

## Product Change Notice

Micron PCN: 31003 Date: 9/19/2013

Type of Change:	End of Life	
Title of Change:	EOL 25nm 16GB and 32GB eMMC JEDEC 4.41	
Description of Change:	Micron 25nm 16GB and 32GB eMMC JEDEC 4.41 products are being discontinued.	
Reason for Change:	Product portfolio optimization and market trend adaptation	
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Product Affected: Product Affected: 25nm 16GB and 32GB eMMC JEDEC 4.41

Affected Micron Part Number	Suggested Replacement Part
MTFC16GLTDV-WT	MTFC16GAAAADV-WT (20nm 16GB eMMC JEDEC 4.51 VFBGA 169b 12 x16 x1.0)
MTFC16GLUDV-WT	
MTFC16GLXDV-WT	
MTFC16GLTAM-WT	
MTFC16GLUAM-WT	
MTFC16GLXAM-WT	
MTFC32GLTDI-WT	MTFC32GAAAADV-WT (20nm 32GB eMMC JEDEC 4.51 VFBGA 169b 12 x16 x1.0)
MTFC32GLUDI-WT	
MTFC32GLXDI-WT	
MTFC32GLTDM-WT	
MTFC32GLUDM-WT	
MTFC32GLXDM-WT	

Note: Per JEDEC Standard JESD46-C Section 3.2.3; lack of acknowledgment of this PCN within 30 days constitutes acceptance of change



Micron Sites Affected:	All Sites	
Schedule for MPNs Being Discontinued:		
Last Buy Date:	28-Feb-2014(*)	
Last Ship Date:	31-Aug-2014	
Schedule for Suggested Replacement:		
Sample Available:	31-Oct-2013	
Qual Data Available:	: 30-Nov-2013	
Product Ship Date:	31-Dec-2013	

\* Orders placed prior to the LTB date are subject to current inventory levels, which may vary based on market conditions and customer demand. Early orders are encouraged.